

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

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# LI0201C800R-12

# UNCONTROLLED

#### PHYSICAL DIMENSIONS:

250

200

150

100

50

MPEDANCE

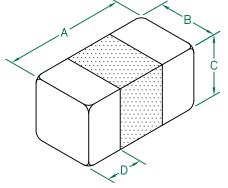
A  $0.60 [.024] \pm 0.03 [.001]$ 

B 0.30 [.012] ± 0.03 [.001]

C 0.30 [.012] ± 0.03 [.001]

D 0.15 [.006] ± 0.05 [.002]

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS





ELECTRICAL CHARACTERISTICS:			
Z @ 100MHz ( Ω )		DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current
Nominal	80		
Minimum	60		
Maximum	100	0.60	300 mA

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 15,000 PCS/REEL, PAPER TAPE.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

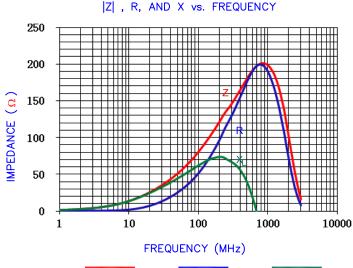
## FREQUENCY (MHz)

100

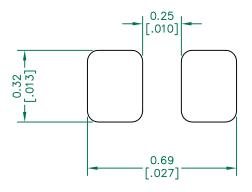
1000

10000

10

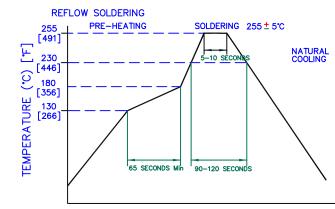


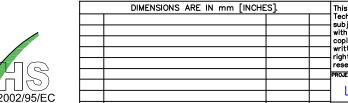
LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763[.030] to this dimension)

#### RECOMMENDED SOLDERING CONDITIONS





DESCRIPTION

DATE

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PROJECT/PART NUMBER:

LIO201C800R-12

DATE: 04/11/14

SCALE: NTS

SHEET:

U

CAD # LIO201C800R-12-A

TOOL # - 1 of 1

AGILENT E4991A RF Impedance/Material Analyzer
AGILENT 16196C Test Fixture.